® 2 Form A **APW212S** APSEMI SOP-8 Load Voltage:60V Load Current:200mA TSCA UPDATE Symbol Rating Units Parameter E534710 V Load Voltage V∟ 60 Load Current IL. А 0.2 2 On-Resistance Ron Ω I/O Breakdown Voltage V/ıo Vrms 2500 (1) 2 input (+) V_{L1}^I (AC,DC) E $I_{E^{\dagger}}$ IL2 VL2 (AC,DC) (-) Input IF2 (+) Input (2) 1 input V_{L1}^I (AC,DC) SOP-8 (-) Input (-/+) E l. VL2 (AC,DC) IL2 1,3. LED Anode 2,4. LED Cathode 5,6. Drain (MOS FET)

APSEMI PhotoRelays

APSEMI Photorelays are the most reliable, technically advanced logic-to-power interface devices. Their basic function is to take a low current signal from a microprocessor to control the switching of both AC and DC loads, while providing an isolation barrier between logic and power. While this function is common to all relays, Photorelays provide distinct advantages over their mechanical counterparts including:

7,8. Drain (MOS FET)

- Long life (No limit on mechanical and electrical
- lifetime)Bounce-free switching
- Higher speed and high frequency switching
- Higher sensitivity (less power consumption)

- No have voltaic arc, bounce, and noise More
- resistant to vibration and impact AC or DC load
- switching •
- Small package size

Immunity to EMI or RFI

Applications

These advantages make APSEI Photorelays the ideal choice for:

- Telecom/Datacom switching .
- Multiplexers •
- Meter reading systems •
- Data acquisition
- Medical equipment .
- Battery monitoring •
- I/O Sub-Systems •

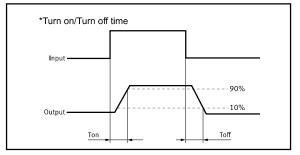
Robotics Aerospace

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- Home/Safety security systems
- Process Control
- **Energy Management**
- Reed Relay EMR Replacement •
- Programmable Controllers

TPYES

Category	Output Rating		Paakaga	Part No.	Pooking Quantity	
	Load Voltage	Load Current	Package	Part NO.	Packing Quantity	
AC/DC	60V	0.2A	SOP-8	APW212S	2000pcs /reel	





Absolute Maximum Ratings (Ta = 25°C)

Item		Symbol	Value	Units	Note
	Continuous LED Current	F	50	mA	
Input	Peak LED Current	FP	1000	mA	f=100Hz, duty=1%
	LED Reverse Voltage	VR	5	V	
	Input Power Dissipation	Pin	75	mW	
Output	Load Voltage	VL	60	V(AC peak or DC)	
	Load Current	L	0.2	A	
	Peak Load Current	Peak	0.5	А	100ms (1 pulse)
	Output Power Dissipation	Pout	450	mW	
Total Powe	Total Power Dissipation		500	mW	
I/O Breakdown Voltage		Vi/o	2500	Vrms	RH=60%, 1min
Operating Temperature		Topr	-40 to 85	°C	
Storage Temperature		Tstg	-40 to 100	C	
Pin Soldering Temperature		T _{sol}	260	°C	10 sec max.

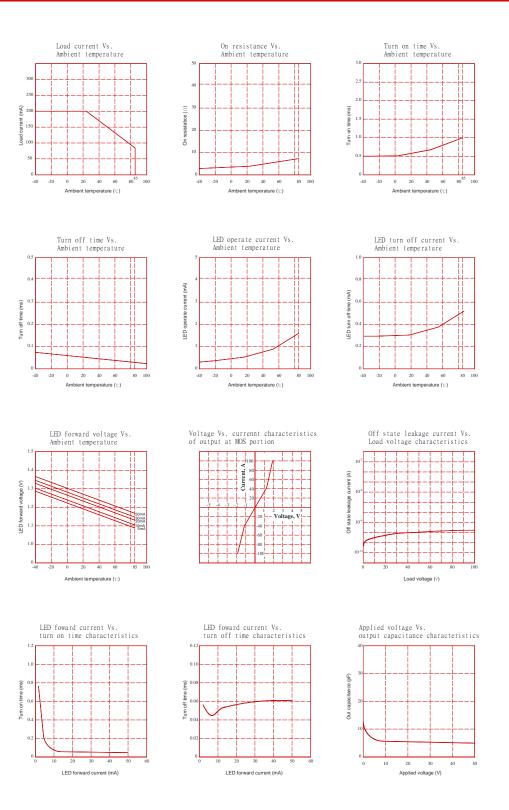
Electrical Characteristics (Ta = 25°C)

	Item	Symbol	MIN.	TYP.	MAX.	Units	Conditions	
	LED Forward Voltage	VF		1.2	1.4	V	l⊧=10mA	
Input	Operation LED Current	Fon		0.5	2.0	mA		
	Recovery LED Current	Foff		0.35	0.5	mA		
	Recovery LED Voltage	VFoff	0.7			V		
Output	On-Resistance	Ron		2	8	Ω	l⊧=5mA,l⊾=100mA, Time to flow is within 1 sec.	
	Off-State Leakage Current	Leak	0.01	0.02	0.1	uA	V₋=Rating	
	Output Capacitance	Cout		6		pF	V∟=0, f=1MHz	
Transmis	Turn-On Time	Ton		0.05	0.2	ms	l⊧=5mA, l∟=100mA,	
sion	Turn-Off Time	Toff		0.05	0.5	ms		
Occurring	I/O Isolation Resistance	Ri⁄o	10 ¹⁰			Ω	DC500V	
Coupled	I/O Capacitance	Сі/о		0.8	1.5	pF	f=1MHz	

Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value): IF ≥5mA and ≤30mA

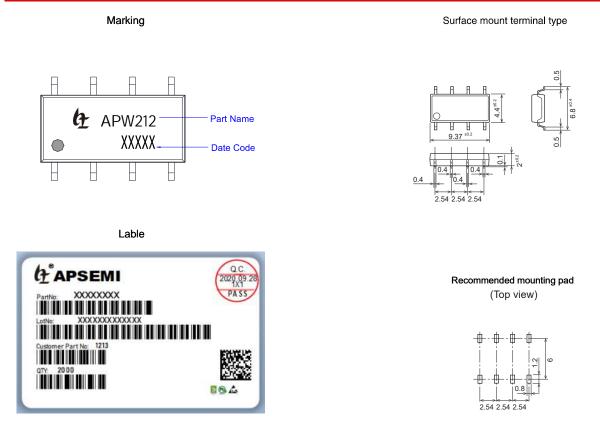


Engineering Data

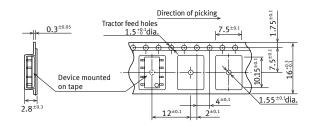




Dimensions and SOP-8 Package Unit: mm

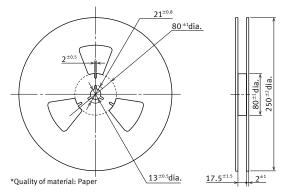


Tape dimensions (tape reel)



Tape dimensions (Unit: mm)

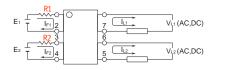
Dimensions of paper tape reel (Unit: mm)





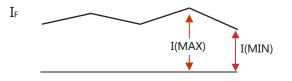
Using Methods

Examples of resistance value to control LED forward current (IF=5mA)



E1 E2	R1 R2(Approx)
3.3V	300 Ω
5.0V	600 Ω
12V	1.9KΩ
24V	4.1K Ω

LED forward current must be more than 5mA , at I(MIN) ,and less than 30mA , at I(MAX).



Recommended Operating Conditions

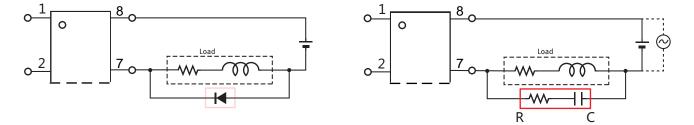
Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value):

Characteristic	Symbol	Min	Тур.	Max	Unit
Forward current	١ _F	5.0	7.0	30	mA

Protection Circuit

Clamp diode is connected in parallel with the load. Absorb capacity with external diode.

CR Snubber is connected in parallel with the load. Absorb capacity with buffer capacity.



When adding diodes, buffer circuits (C-R), and other protections, they need to be installed near the MOS RELAY to be effective. Adding protection elements may result in a slow reset time, so adjust them according to the actual situation before use.

Note: When developing designs using this product, perform the expected performance of the equipment under the operating conditions recommended by the guidelines in this document. Continuous use under heavy loads (including, but not limited to, the application of high temperatures/current/voltage and significant changes in temperature, etc.) may result in deterioration of the reliability of this product.

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